



香港低碳設計協會

Low Carbon Design Society of Hong Kong

PHOTO

Individual Membership Application Form

| | | | |
|-------------------------------------------------------------------|--------------------|---------------------------------------|--|
| Full Name (Chinese): | | * Same as ID/ Passport | |
| (English) : | | Other Name: *Mr / Ms | |
| Date of Birth: | Nationality: | E-mail Address: | |
| Telephone: | Fax: | Mobile: | |
| Correspondence Address: | | | |
| | | | |
| Education Level Obtained: (Degree)..... (Master)..... (PhD) | | | |
| University / College: | | Date obtained: | |
| Other (Please specify): | | Date obtained: | |
| Other Prof. Qualification: | | Date obtained: | |
| Company / Self-employed* | | | |
| Company Name: | | | |
| Position: | | Company Address: | |
| | | | |
| Telephone: | | Fax: | |
| | | E-mail Address: | |
| Membership Category & Membership Fee: | | | |
| <input type="checkbox"/> Member 會員 : | | Entry Fee: HKD300; Annual Fee: HKD500 | |
| <input type="checkbox"/> Junior Member 初級會員 < Age 25 or below > : | | Entry Fee: Waived; Annual Fee: HKD200 | |

I wish to apply for the membership of Low Carbon Design Society of Hong Kong (LCDSHK), agree to accept the terms of constitution of the Society and pay the entry & annual subscription fee when called upon. I understand that the Executive Committee has the authority to refuse any application for membership and is not bound to state the reason for so doing.

***** I declare that the above information submitted is all true to the best of my knowledge.**

Signed:HKID / Passport*:<Delete where applicable>

Date:

Would you participate in our working group to help the growth of the society?

YES NO < Please put a tick to select >

Disclaimer: All personal information you submit on this form is abided by the privacy ordinance of Hong Kong and will be used for the purpose of processing your application only.

FOR OFFICAL USE ONLY

Application Form received by: on

Approved by Membership Assessment Panel: on

Approved by Membership Committee: on

Approved at the Meeting of the Executive Committee held on